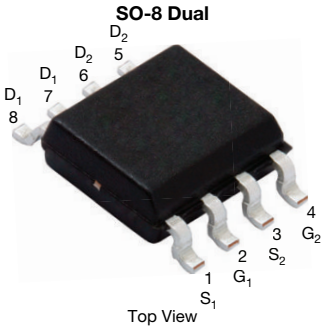
N- and P-Channel 60 V (D-S) MOSFET



Top View

FEATURES

- TrenchFET® Gen IV power MOSFET
- 100 % R_g and UIS tested
- Fully lead (Pb)-free device
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

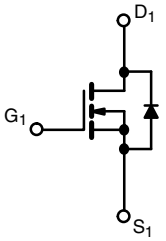
Pb-free

RoHS COMPLIANT

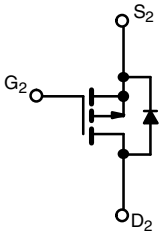
HALOGEN FREE Available

APPLICATIONS

- CCFL Inverter
- FAN control
- Load switch



N-Channel MOSFET



P-Channel MOSFET

PRODUCT SUMMARY		
	N-CHANNEL	P-CHANNEL
V_{DS} (V)	60	-60
$R_{DS(on)}$ (Ω) at V_{GS} = ± 10 V	0.029	0.120
$R_{DS(on)}$ (Ω) at V_{GS} = ± 4.5 V	0.038	0.150
Q_g typ. (nC)	3.3	8
I_D (A) [a]	8	-4.1
Configuration	N- and p-pair	

ORDERING INFORMATION	
Package	SO-8
Lead (Pb)-free and halogen-free	Si4534DY-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted)

PARAMETER		SYMBOL	N-CHANNEL	P-CHANNEL	UNIT
Drain-source voltage		V_{DS}	60	-60	V
Gate-source voltage		V_{GS}	± 20	± 20	
Continuous drain current (T_J = 150 °C)	T_C = 25 °C	I_D	8 [a]	-4.1	A
	T_C = 70 °C		6.6	-3.3	
	T_A = 25 °C		6.2 [b, c]	-3 [b, c]	
	T_A = 70 °C		5 [b, c]	-2.4 [b, c]	
Pulsed drain current (10 µs pulse width)		I_{DM}	32	-25	
Source drain current diode current	T_C = 25 °C	I_S	3	3	
	T_A = 25 °C		1.7 [b, c]	-1.7 [b, c]	
Single pulse avalanche current	L = 0.1 mH	I_{AS}	10	15	
Single pulse avalanche energy		E_{AS}	5	11	mJ
Maximum power dissipation	T_C = 25 °C	P_D	3.6	3.6	W
	T_C = 70 °C		2.3	2.3	
	T_A = 25 °C		2 [b, c]	2 [b, c]	
	T_A = 70 °C		1.3 [b, c]	1.3 [b, c]	
Operating junction and storage temperature range		T_J, T_{stg}	-55 to +150		°C

THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	N-CHANNEL		P-CHANNEL		UNIT
			TYP.	MAX.	TYP.	MAX.	
Maximum junction-to-ambient [b, d]	t ≤ 10 s	R_{thJA}	50	62.5	50	62.5	°C/W
Maximum junction-to-foot (drain)	Steady state	R_{thJF}	28	35	27	34	

Notes

a. Package limited
b. Surface mounted on 1" x 1" FR4 board
c. t = 10 s
d. Maximum under steady state conditions is 110 °C/W for N-channel and P-channel

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SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)							
PARAMETER	**SYMBOL**	**TEST CONDITIONS**		**MIN.**	**TYP. [a]**	**MAX.**	**UNIT**
Static							
Drain-source breakdown voltage	V_{DS}	V_{GS} = 0 V, I_D = 250 µA	N-Ch	60	-	-	V
		V_{GS} = 0 V, I_D = -250 µA	P-Ch	-60	-	-	
V_{DS} temperature coefficient	$\Delta V_{DS}/T_J$	I_D = 250 µA	N-Ch	-	33	-	mV
		I_D = -250 µA	P-Ch	-	50	-	
$V_{GS(th)}$ temperature coefficient	$\Delta V_{GS(th)}/T_J$	I_D = 250 µA	N-Ch	-	-4.8	-	
		I_D = -250 µA	P-Ch	-	4	-	
Gate threshold voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250 µA	N-Ch	1	-	3	V
		V_{DS} = V_{GS}, I_D = -250 µA	P-Ch	-1	-	-3	
Gate-body leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V	N-Ch	-	-	100	nA
			P-Ch	-	-	-100	
Zero gate voltage drain current	I_{DSS}	V_{DS} = 60 V, V_{GS} = 0 V	N-Ch	-	-	1	µA
		V_{DS} = -60 V, V_{GS} = 0 V	P-Ch	-	-	-1	
		V_{DS} = 60 V, V_{GS} = 0 V, T_J = 70 °C	N-Ch	-	-	15	
		V_{DS} = -60 V, V_{GS} = 0 V, T_J = 70 °C	P-Ch	-	-	-15	
Drain-source on-state resistance [b]	$R_{DS(on)}$	V_{GS} = 10 V, I_D = 5 A	N-Ch	-	0.022	0.029	Ω
		V_{GS} = -10 V, I_D = -3.1 A	P-Ch	-	0.100	0.120	
		V_{GS} = 4.5 V, I_D = 4 A	N-Ch	-	0.029	0.038	
		V_{GS} = -4.5 V, I_D = -0.2 A	P-Ch	-	0.126	0.150	
Forward transconductance [b]	g_{fs}	V_{DS} = 10 V, I_D = 10 A	N-Ch	-	23	-	S
		V_{DS} = -15 V, I_D = -3.1 A	P-Ch	-	8.5	-	
Dynamic [a]							
Input capacitance	C_{iss}	N-channel V_{DS} = 30 V, V_{GS} = 0 V, f = 1 MHz P-channel V_{DS} = -15 V, V_{GS} = 0 V, f = 1 MHz	N-Ch	-	420	-	pF
			P-Ch	-	650	-	
Output capacitance	C_{oss}		N-Ch	-	92	-	
			P-Ch	-	95	-	
Reverse transfer capacitance	C_{rss}		N-Ch	-	4	-	
			P-Ch	-	60	-	
Total gate charge	Q_g	V_{DS} = 30 V, V_{GS} = 10 V, I_D = 5 A	N-Ch	-	7.1	11	nC
		V_{DS} = -30 V, V_{GS} = -10 V, I_D = -3.1 A	P-Ch	-	14.5	22	
		V_{DS} = 30 V, V_{GS} = 4.5 V, I_D = 5 A	N-Ch	-	3.3	5	
		V_{DS} = -30 V, V_{GS} = -4.5 V, I_D = -3.1 A	P-Ch	-	8	12	
Gate-source charge	Q_{gs}	N-channel V_{DS} = 30 V, V_{GS} = 4.5 V, I_D = 5 A P-channel V_{DS} = -30 V, V_{GS} = -4.5 V, I_D = -3.1 A	N-Ch	-	1.7	-	
			P-Ch	-	2.2	-	
Gate-drain charge	Q_{gd}		N-Ch	-	0.9	-	
			P-Ch	-	3.7	-	
Gate resistance	R_g	f = 1 MHz	N-Ch	0.3	1.6	3.2	Ω
			P-Ch	3	14	28	

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SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)							
PARAMETER	**SYMBOL**	**TEST CONDITIONS**		**MIN.**	**TYP.** [a]	**MAX.**	**UNIT**
Dynamic [a]							
Turn-on delay time	$t_{d(on)}$	N-channel V_{DD} = 30 V, R_L = 6 Ω, $I_D \cong$ 5 A, V_{GEN} = 4.5 V, R_g = 1 Ω P-channel V_{DD} = -30 V, R_L = 12.5 Ω, $I_D \cong$ -2.4 A, V_{GEN} = -4.5 V, R_g = 1 Ω	N-Ch	-	12	25	ns
			P-Ch	-	30	60	
Rise time	t_r		N-Ch	-	16	35	
			P-Ch	-	70	140	
Turn-off delay time	$t_{d(off)}$		N-Ch	-	11	25	
			P-Ch	-	40	80	
Fall time	t_f		N-Ch	-	5	10	
			P-Ch	-	30	60	
Turn-on delay time	$t_{d(on)}$	N-channel V_{DD} = 30 V, R_L = 6 Ω, $I_D \cong$ 5 A, V_{GEN} = 10 V, R_g = 1 Ω P-channel V_{DD} = -30 V, R_L = 12.5 Ω, $I_D \cong$ -2.4 A, V_{GEN} = -10 V, R_g = 1 Ω	N-Ch	-	10	20	
			P-Ch	-	10	20	
Rise time	t_r		N-Ch	-	5	10	
			P-Ch	-	13	25	
Turn-off delay time	$t_{d(off)}$		N-Ch	-	15	30	
			P-Ch	-	35	70	
Fall time	t_f		N-Ch	-	5	10	
			P-Ch	-	30	60	
Drain-Source Body Diode Characteristics							
Continuous source-drain diode current	I_S	T_C = 25 °C	N-Ch	-	-	8	A
			P-Ch	-	-	-2.8	
Pulse diode forward current [a]	I_{SM}		N-Ch	-	-	32	
			P-Ch	-	-	-25	
Body diode voltage	V_{SD}	I_S = 2 A	N-Ch	-	0.8	1.2	V
		I_S = -2 A	P-Ch	-	-0.8	-1.2	
Body diode reverse recovery time	t_{rr}	N-channel I_F = 5 A, di/dt = 100 A/µs, T_J = 25 °C P-channel I_F = -2 A, di/dt = -100 A/µs, T_J = 25 °C	N-Ch	-	14	30	ns
			P-Ch	-	30	50	
Body diode reverse recovery charge	Q_{rr}		N-Ch	-	10	20	nC
			P-Ch	-	35	60	
Reverse recovery fall time	t_a		N-Ch	-	8	-	ns
			P-Ch	-	16	-	
Reverse recovery rise time	t_b		N-Ch	-	6	-	
			P-Ch	-	14	-	

Notes

a. Guaranteed by design, not subject to production testing

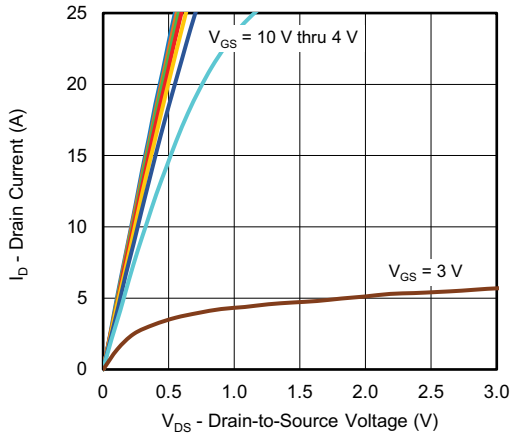
b. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

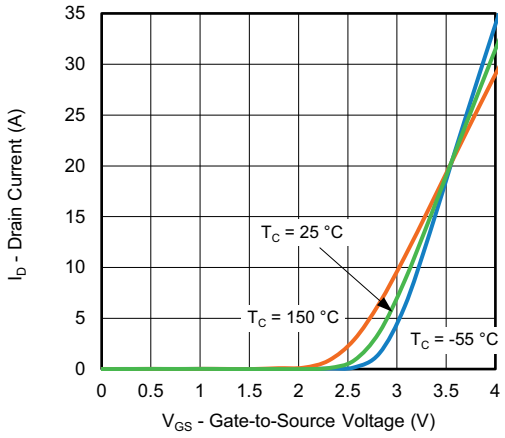
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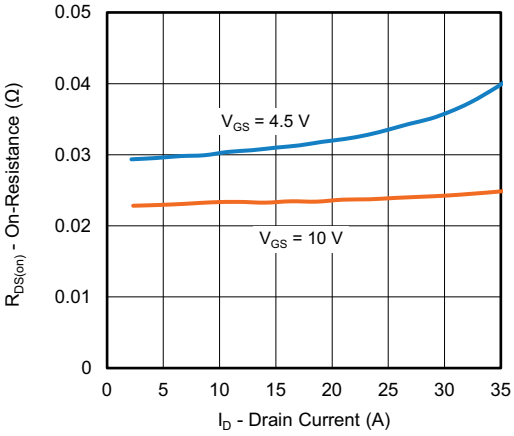
N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



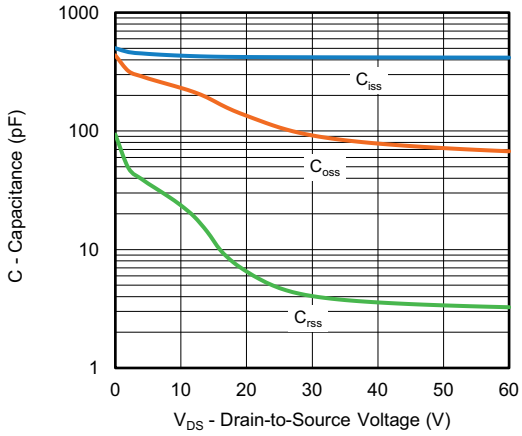
Output Characteristics



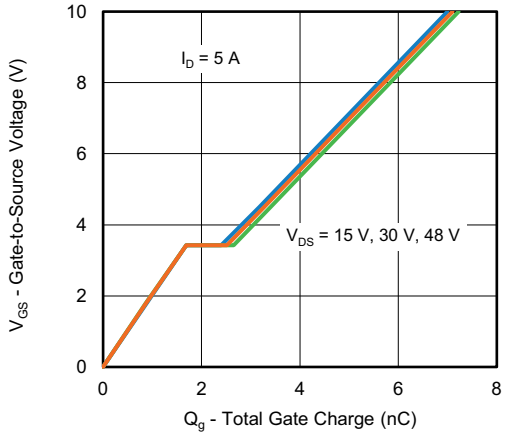
Transfer Characteristics



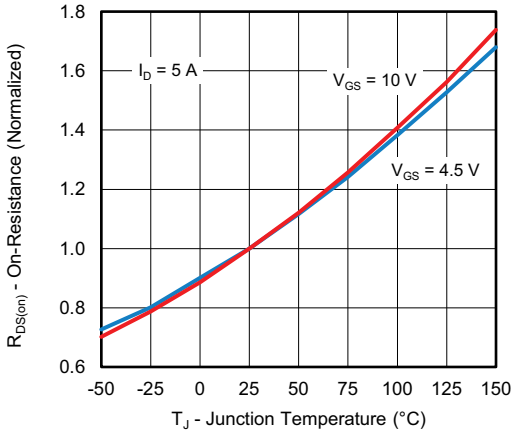
On-Resistance vs. Drain Current and Gate Voltage



Capacitance



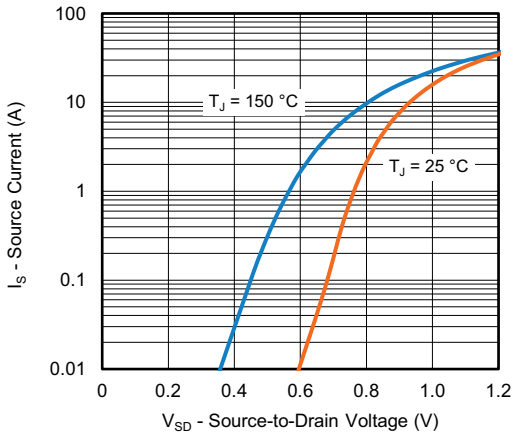
Gate Charge



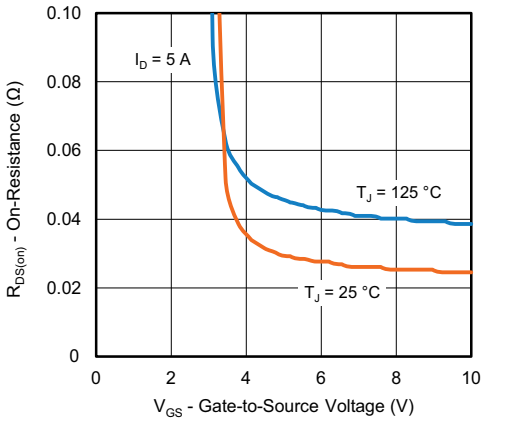
On-Resistance vs. Junction Temperature

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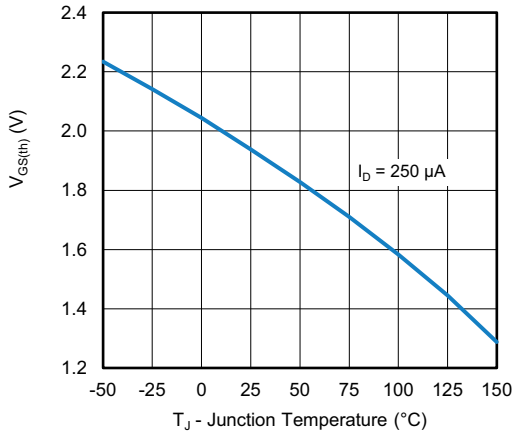
N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



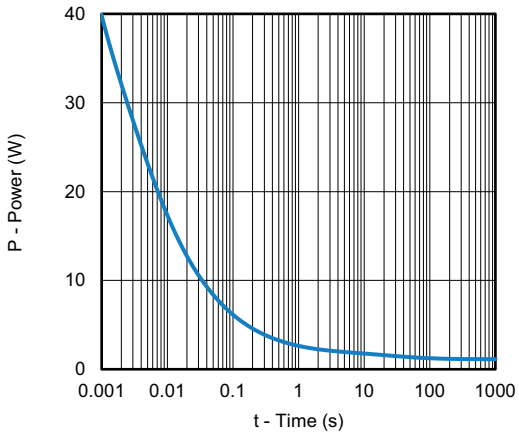
Source-Drain Diode Forward Voltage



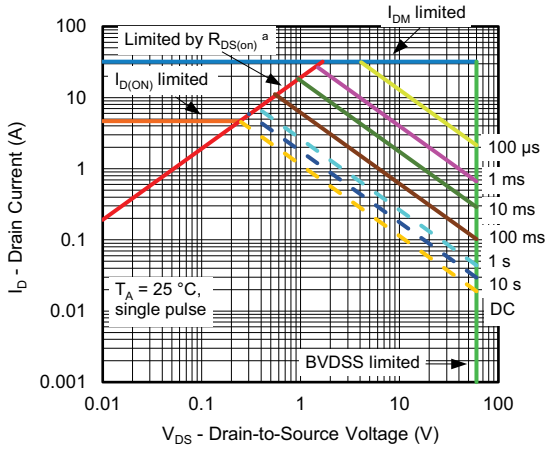
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



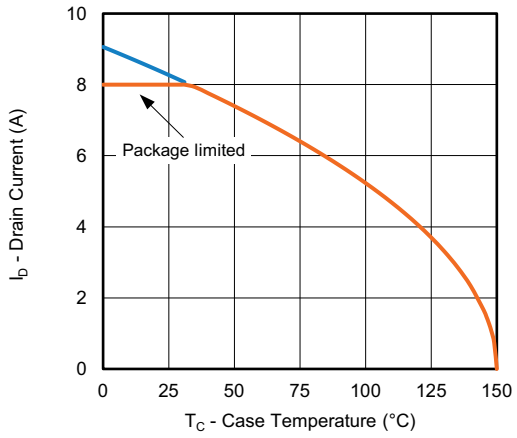
Single Pulse Power, Junction-to-Ambient



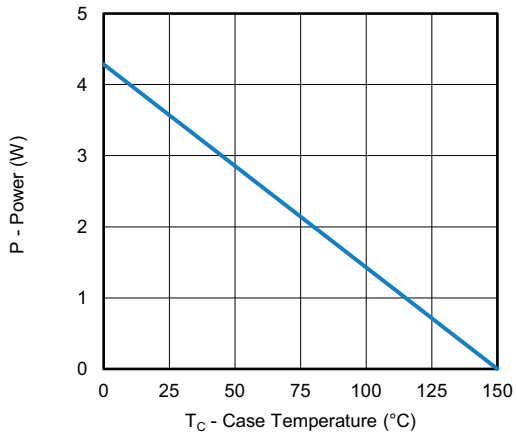
Safe Operating Area

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N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating [a]



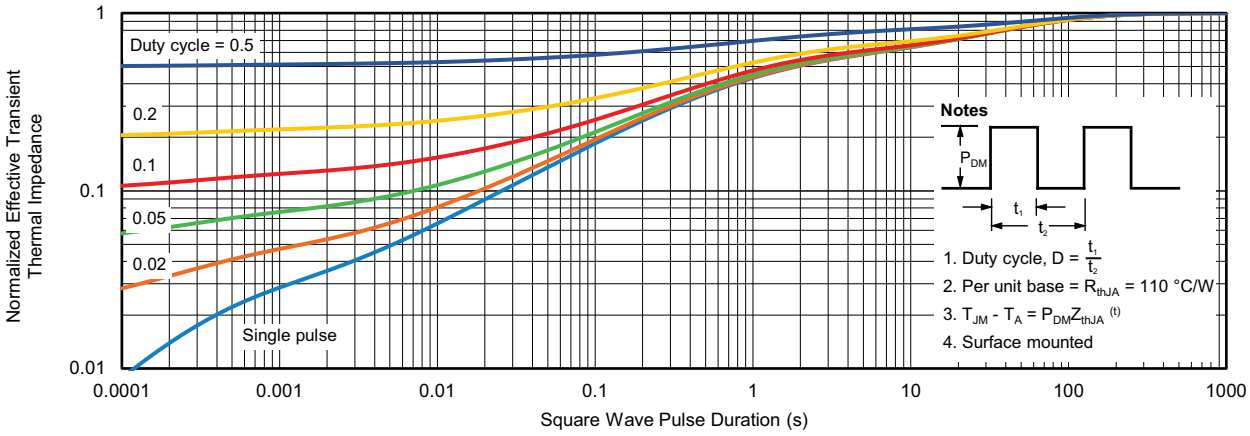
Power Derating

Note

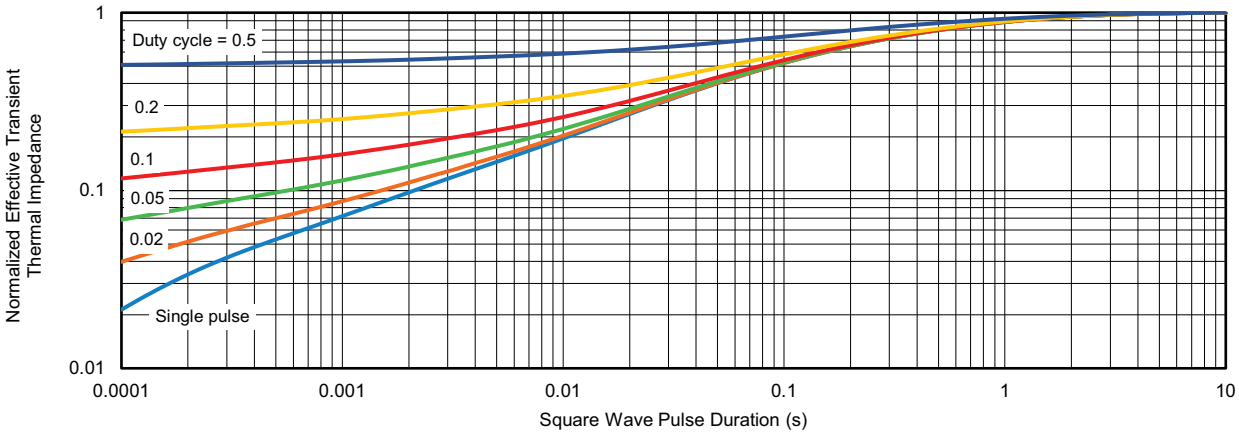
a. The power dissipation P_D is based on T_J max = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

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N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



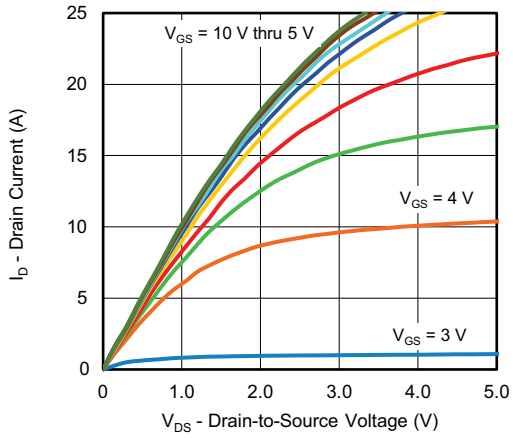
Normalized Thermal Transient Impedance, Junction-to-Ambient



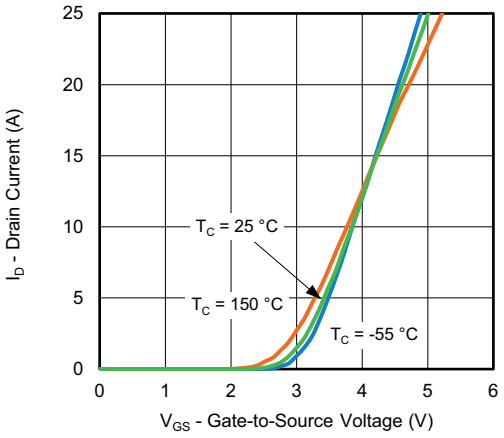
Normalized Thermal Transient Impedance, Junction-to-Case

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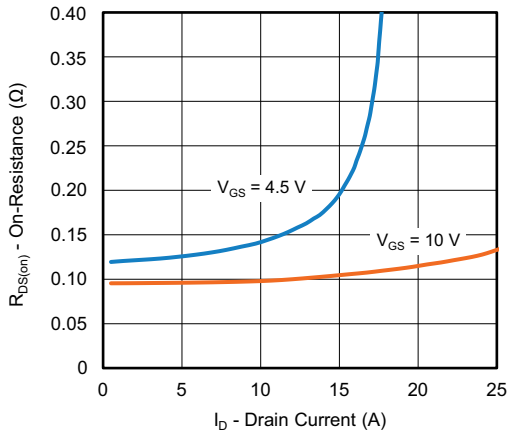
P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



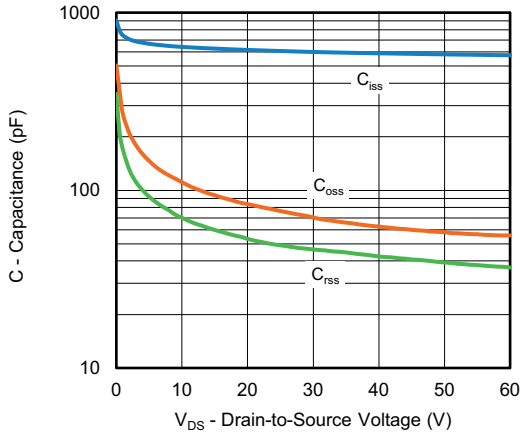
Output Characteristics



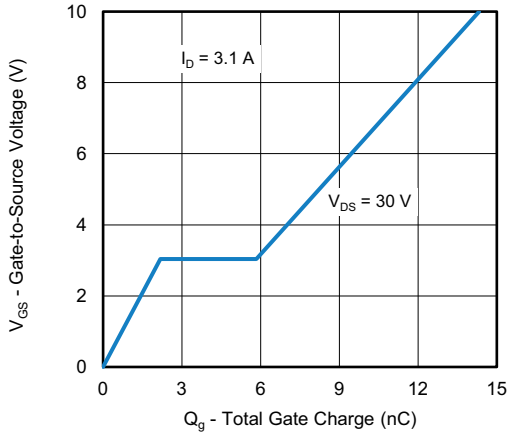
Transfer Characteristics



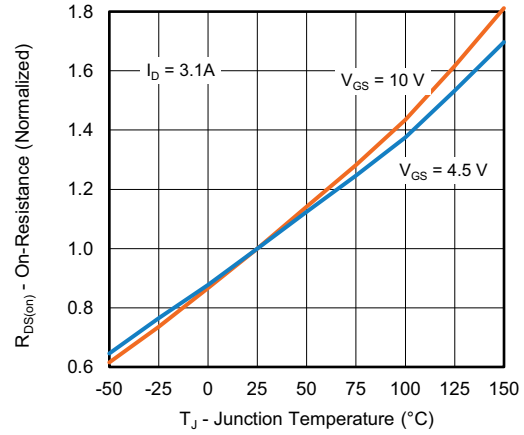
On-Resistance vs. Drain Current



Capacitance



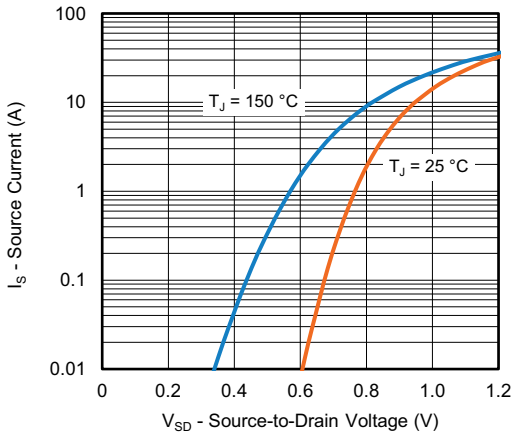
Gate Charge



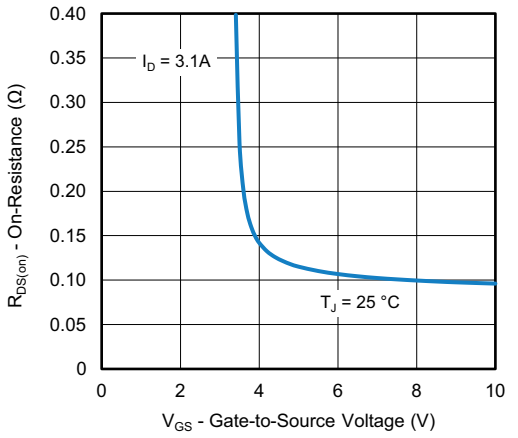
On-Resistance vs. Junction Temperature

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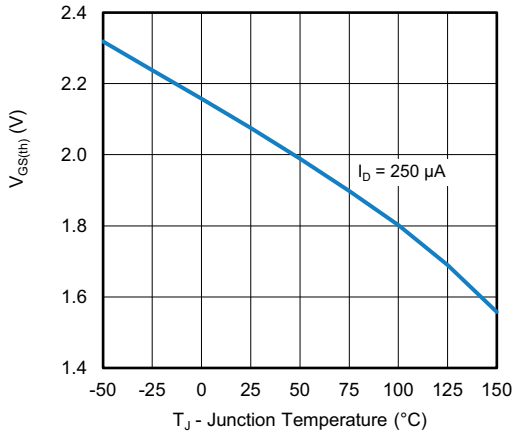
P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



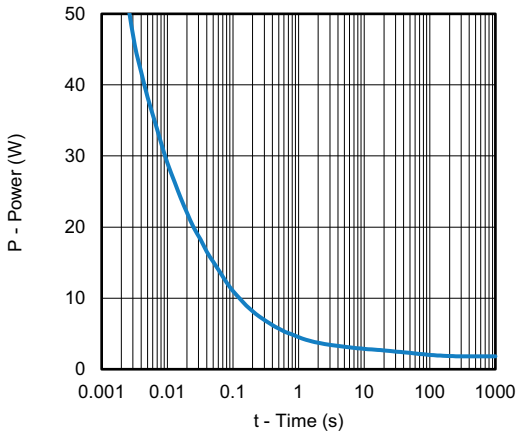
Source-Drain Diode Forward Voltage



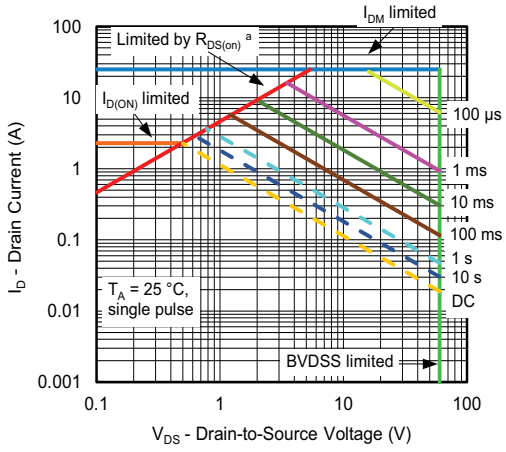
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



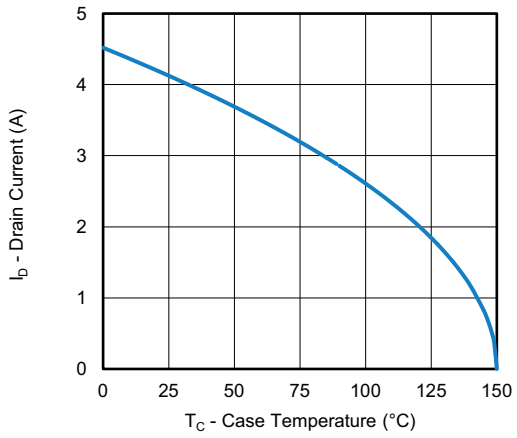
Single Pulse Power



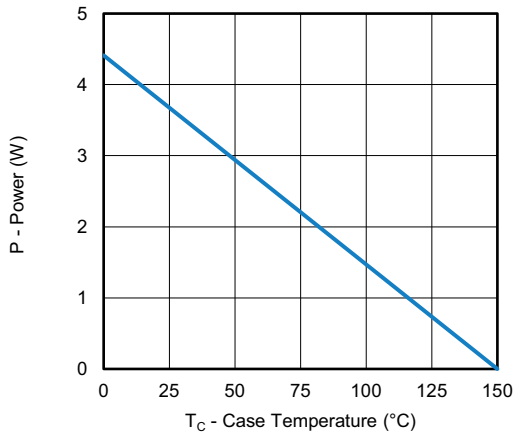
Safe Operating Area, Junction-to-Case

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P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating [a]



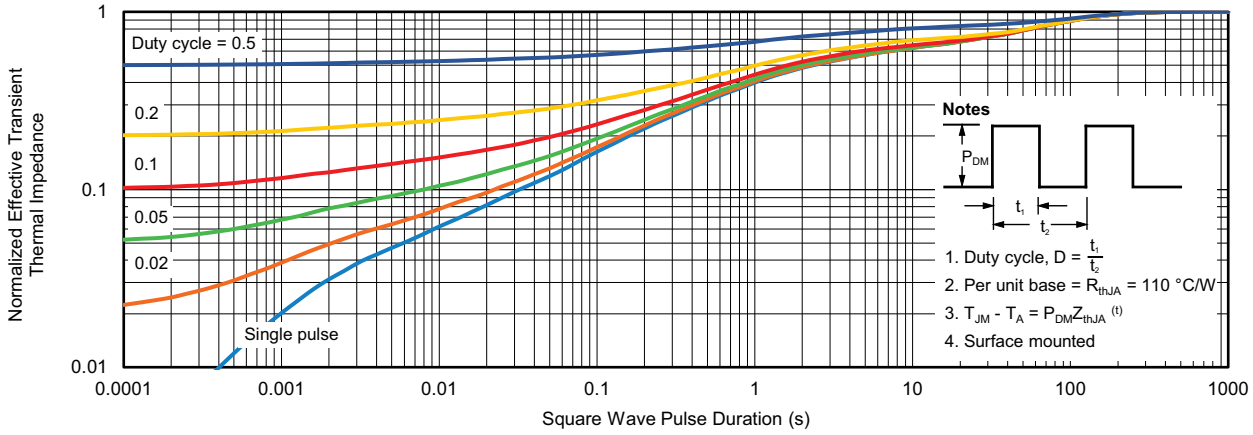
Power Derating, Junction-to-Foot

Note

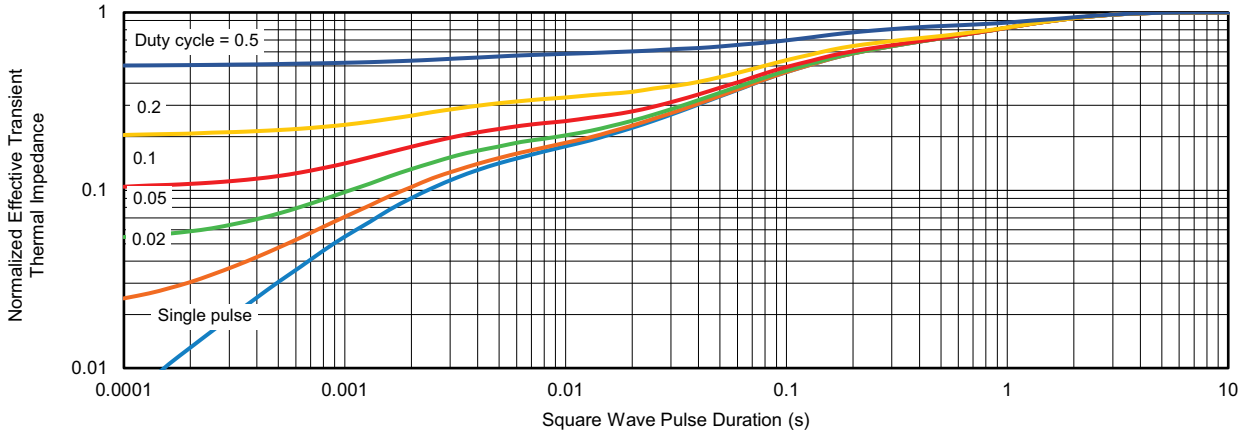
a. The power dissipation P_D is based on T_J max = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

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Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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